

NCE N-Channel Enhancement Mode Power MOSFET

Description

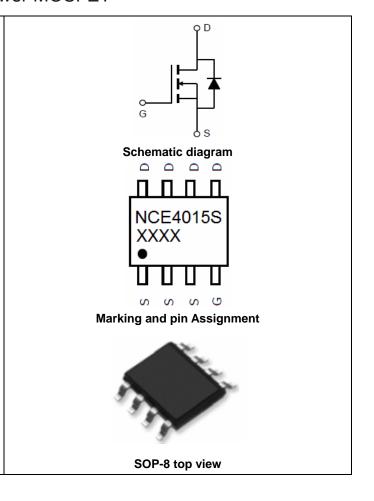
The NCE4015S uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- V_{DS} =40V,I_D =15A
 - $R_{DS(ON)}$ <10m Ω @ V_{GS} =10V (Typ. 6.1 m Ω)
 - $R_{DS(ON)}$ <15m Ω @ V_{GS} =4.5V (Typ. 11.4 m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4015S	NCE4015S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous	I _D	15	Α
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	10.6	Α
Pulsed Drain Current	I _{DM}	70	А
Maximum Power Dissipation	P _D	3.1	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{θJA}	40	°C/W
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NCE4015S



Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0 V I_D =250 μ A	V _{GS} =0V I _D =250μA 40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =40 V , V_{GS} =0 V	V _{DS} =40V,V _{GS} =0V -		1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)	On Characteristics (Note 3)					
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS} , I_D =250 μ A	1.2	1.8	2.5	V
Drain-Source On-State Resistance	Б	V_{GS} =10V, I_D =10A	-	6.1	10	mΩ
Dialii-Source Oii-State Resistance	n-State Resistance $R_{DS(ON)} = \frac{V_{GS} = 1.5V, I_D = 10.7V}{V_{GS} = 4.5V, I_D = 8A}$		-	11.4	15	mΩ
Forward Transconductance	g FS	V_{DS} =5 V , I_D =10 A		80	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{Iss}	\/ -20\/\/ -0\/	-	3090	-	PF
Output Capacitance	Coss	V_{DS} =20 V , V_{GS} =0 V , F=1.0MHz	-	328	-	PF
Reverse Transfer Capacitance	C _{rss}	r-1.0Winz	-	273	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	7	-	nS
Turn-on Rise Time	t _r	V_{DD} =20 V , R_L =2 Ω	-	20	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	34	-	nS
Turn-Off Fall Time	t _f		-	19	-	nS
Total Gate Charge	Qg	\/ -20\/ L -40A	-	60		nC
Gate-Source Charge	Q_{gs}	V_{DS} =20V, I_D =10A, V_{GS} =10V	-	8.1		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	16.9		nC
Drain-Source Diode Characteristics	1		•	•		
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =10A	-		1.2	V
Diode Forward Current (Note 2)	I _S		-	-	15	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 10A	-	31	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	33	-	nC

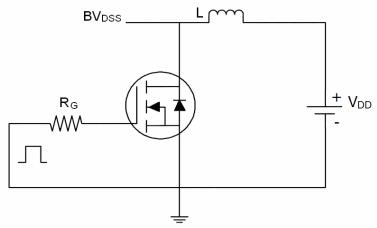
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

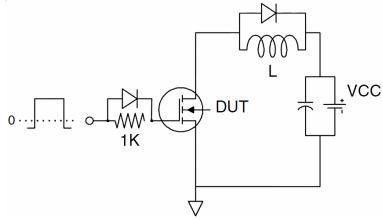
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Test circuit

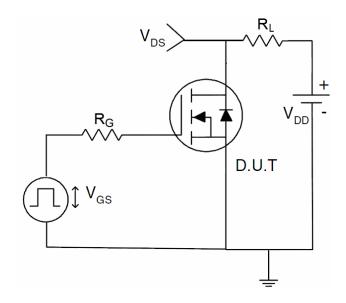
1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

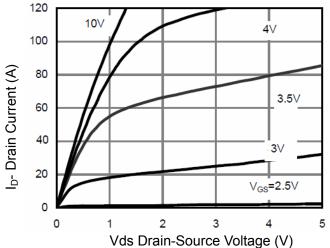


Figure 1 Output Characteristics

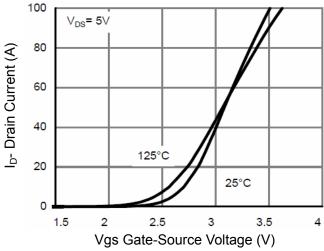


Figure 2 Transfer Characteristics

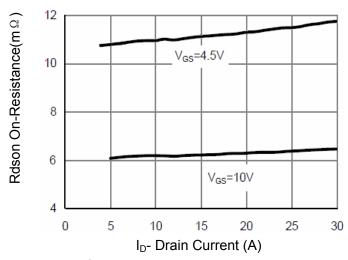


Figure 3 Rdson- Drain Current

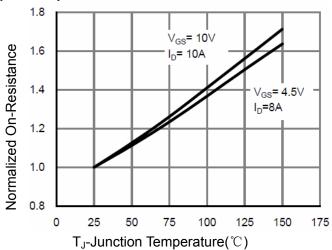


Figure 4 Rdson-JunctionTemperature

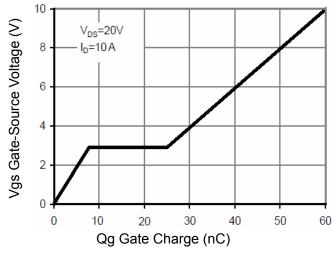


Figure 5 Gate Charge

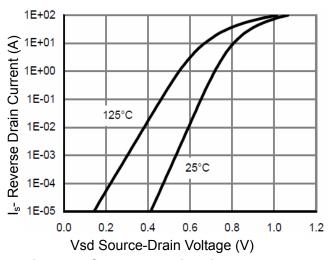
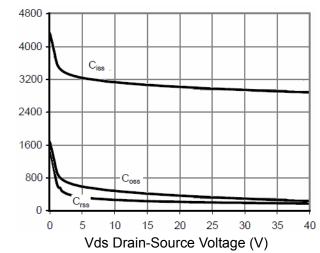


Figure 6 Source- Drain Diode Forward



C Capacitance (pF)



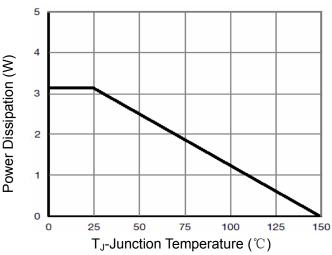
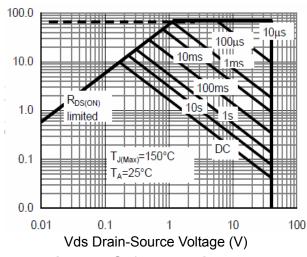


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



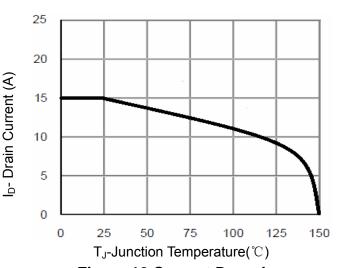


Figure 8 Safe Operation Area

Figure 10 Current De-rating

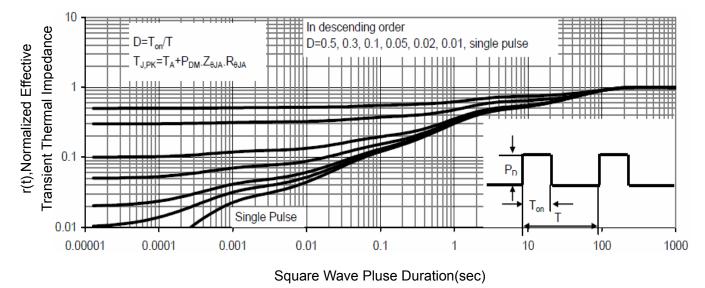
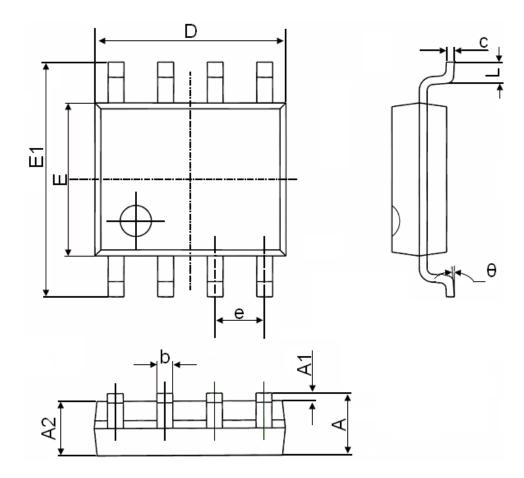


Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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Pb Free Product
NCE4015S

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